

^h
~~13.~~ The method of ~~Claim 12~~^A wherein said predetermined distance from said facing surfaces of said heat sink to said facing surface of said article is generally between 0.05 to 0.25 in.

Contd
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^u
~~14.~~ The method of ~~Claim 12~~^A wherein said heat sink is pre-cooled to a temperature in the range of approximately -50° C. to -200° C. ^B ^B

[^]
~~15.~~ The method of ~~Claim 12~~^A wherein said high thermal conductivity gas is selected from the group consisting of helium and hydrogen.

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B
L
~~16.~~ The method of ~~Claim 12~~^A wherein said high thermal conductivity gas pressure is maintained in the range of approximately 1 to 10 Torr.

REMARKS

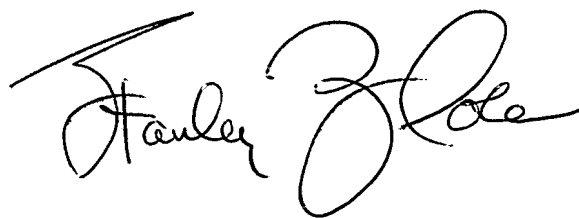
This amendment is to continue the parent application in a new continuation application. Applicant has added new claims and deleted the allowed claims of the parent application. A missing serial number has also been inserted.

As indicated in the covering letter, the parent application is currently pending. It is scheduled to issue shortly. It is intended to file a terminal disclaimer in this application once the expiration date of the

parent becomes known so that any patent that issues in this case will not extend beyond the expiration date of the patent that issues from the parent application.

The purpose in filing this application is to assure that applicant obtains claim coverage believed to be appropriate for applicant's invention.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Stanley Z. Cole". The signature is fluid and cursive, with the first name "Stanley" written in a more legible script and the last name "Cole" in a more stylized, cursive form.

Stanley Z. Cole

Attorney for Applicant

Registration No. 17,654

(415) 941 0887